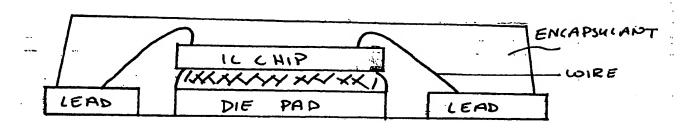
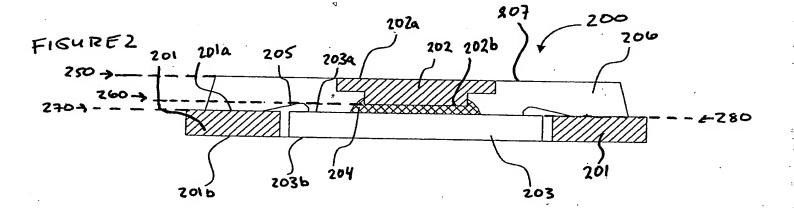
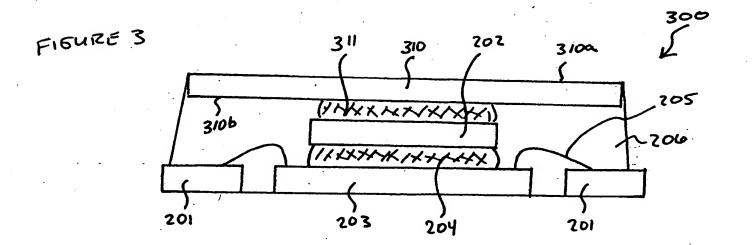
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## FIGURE 1 PRIOR ART

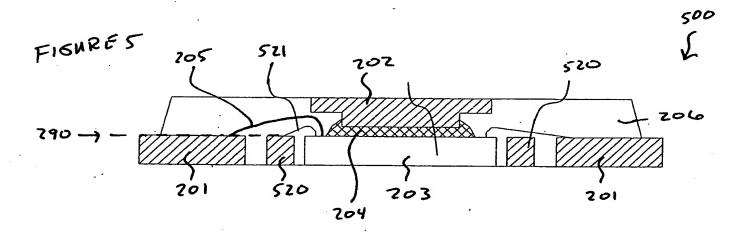


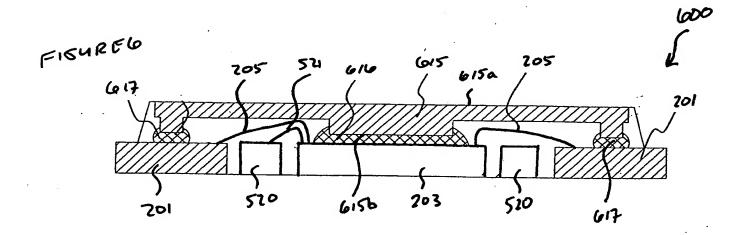
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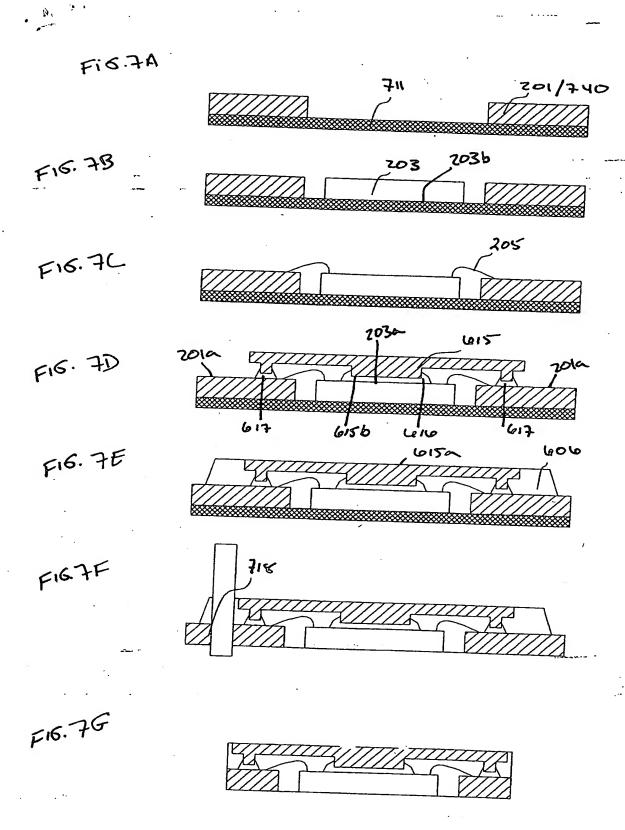
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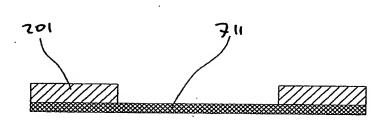
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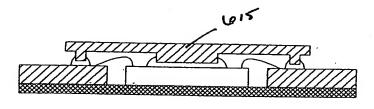
FIGURE 3 H

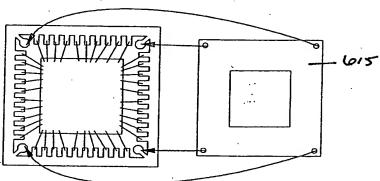


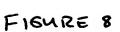
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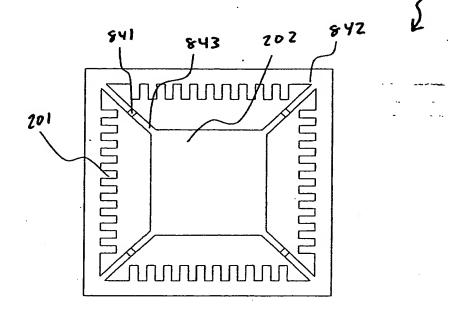
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FIGURE 7 I



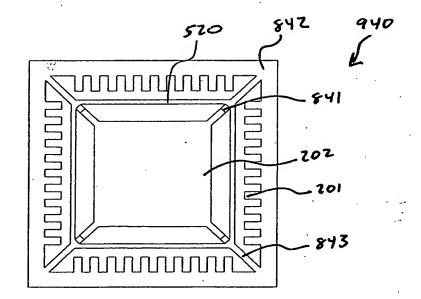






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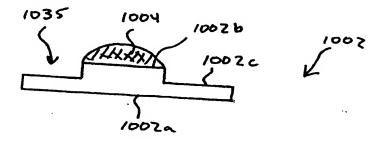
FIGURE 9



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FIGURE 10



FIGUREII

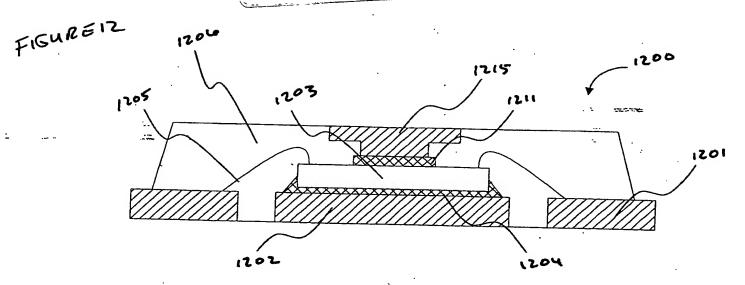
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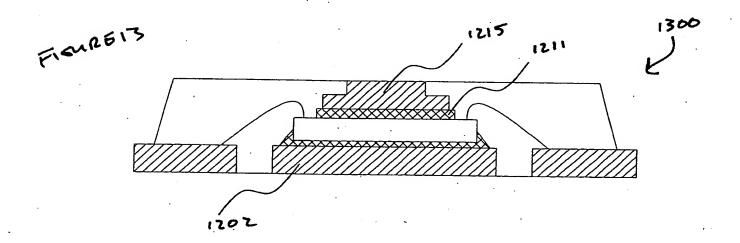
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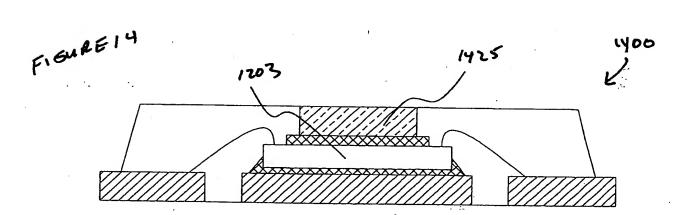
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